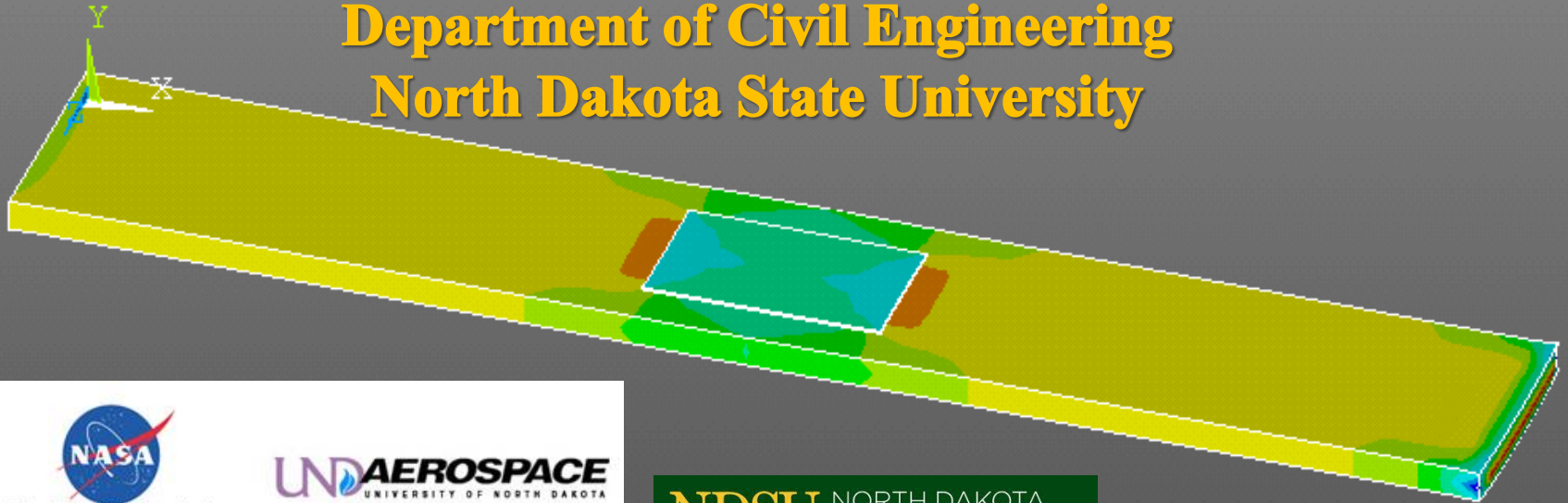


# An Intelligent System for Real-Time Stress Alleviation

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and  
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North Dakota State University



The NDSGC is funded  
through a NASA training grant



**NDSU** NORTH DAKOTA  
STATE UNIVERSITY

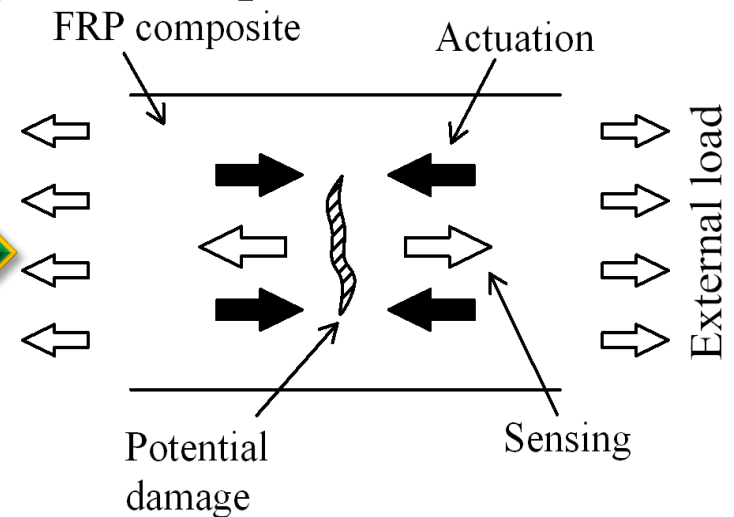
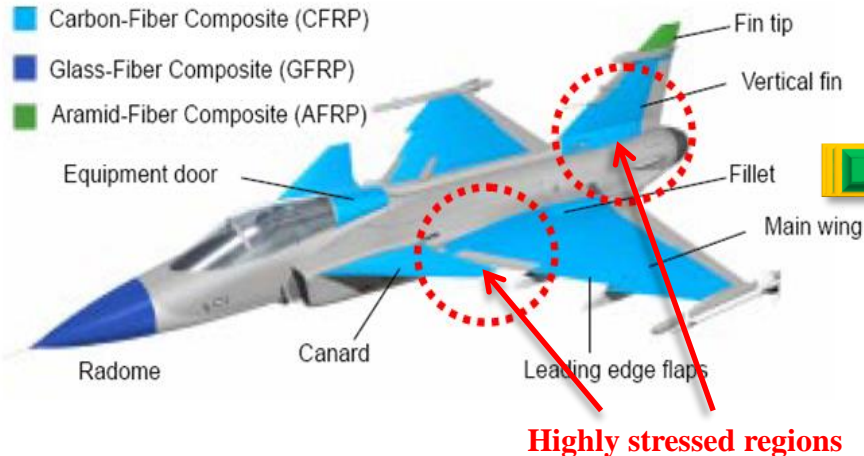
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# Introduction

## Purpose of Research

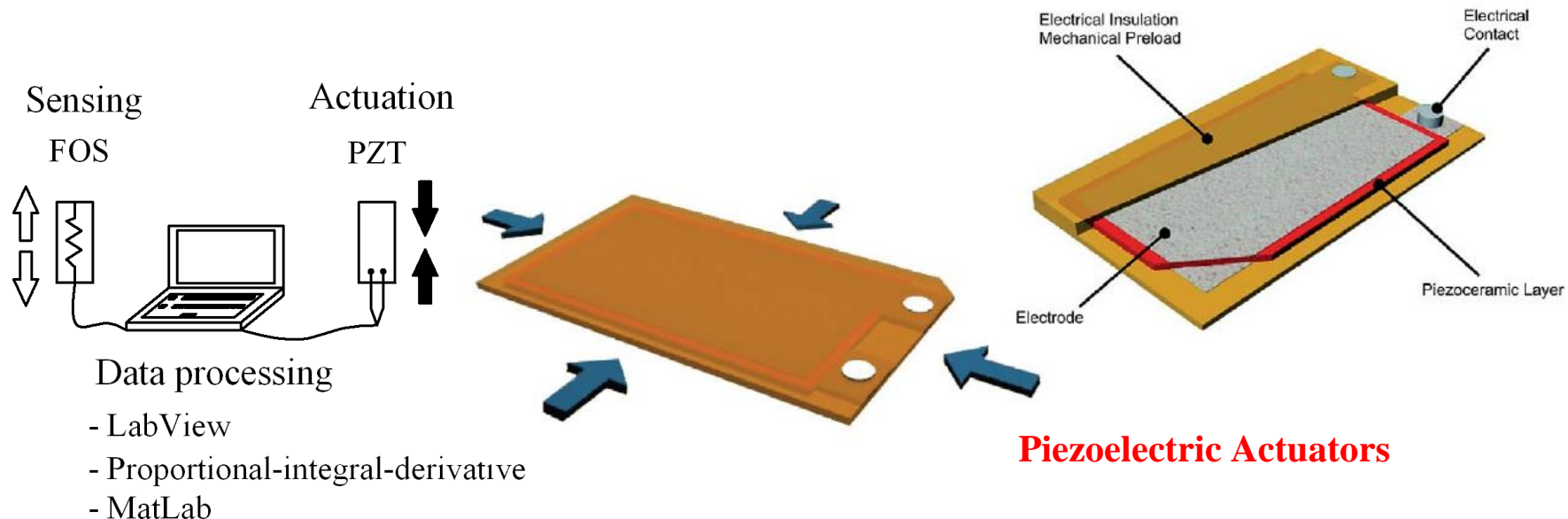
- **Fundamentally reframe our knowledge of composite materials and structures**
- **Diagnose potential damage and actively alleviate the damage in real-time**
- **Save significant maintenance, repair and replacement cost of composite structures**



# Introduction

## Purpose of Research

- Develop a detection and trigger system for active stress alleviation
- Provide an advanced data processing method and determine a manufacturing approach
- Determine the best material to use for actuation



# Introduction

## Scope of Research

### **Phase 1:**

**Determine an experiment procedure and material selection through theoretical modeling**

### **Phase 2:**

**Improve experiment and create active detection and triggering system**

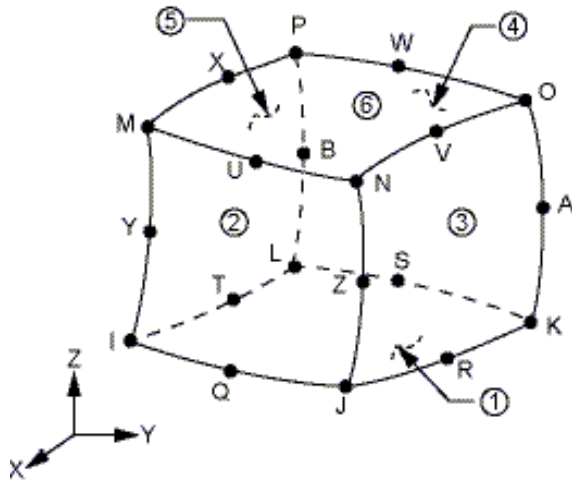
### **Phase 3:**

**Design recommendations for applications involving composite structure stress alleviation**

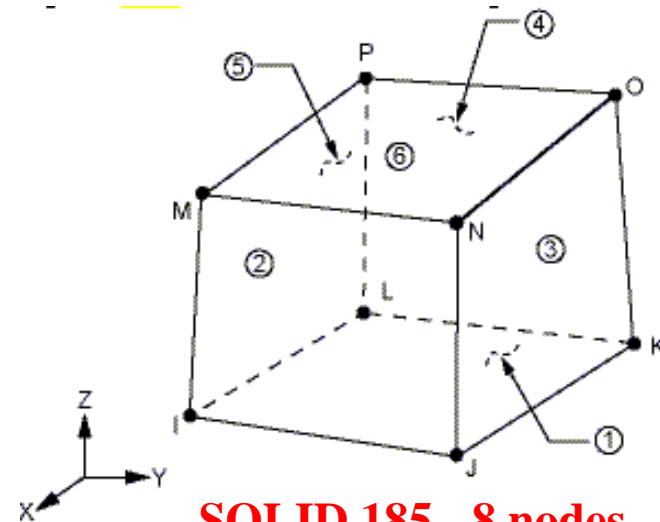
# Theoretical Modeling

## ANSYS (Finite Element Background)

- The finite element method is the process of discretizing a structure or system into smaller parts called elements
- ANSYS elements used:



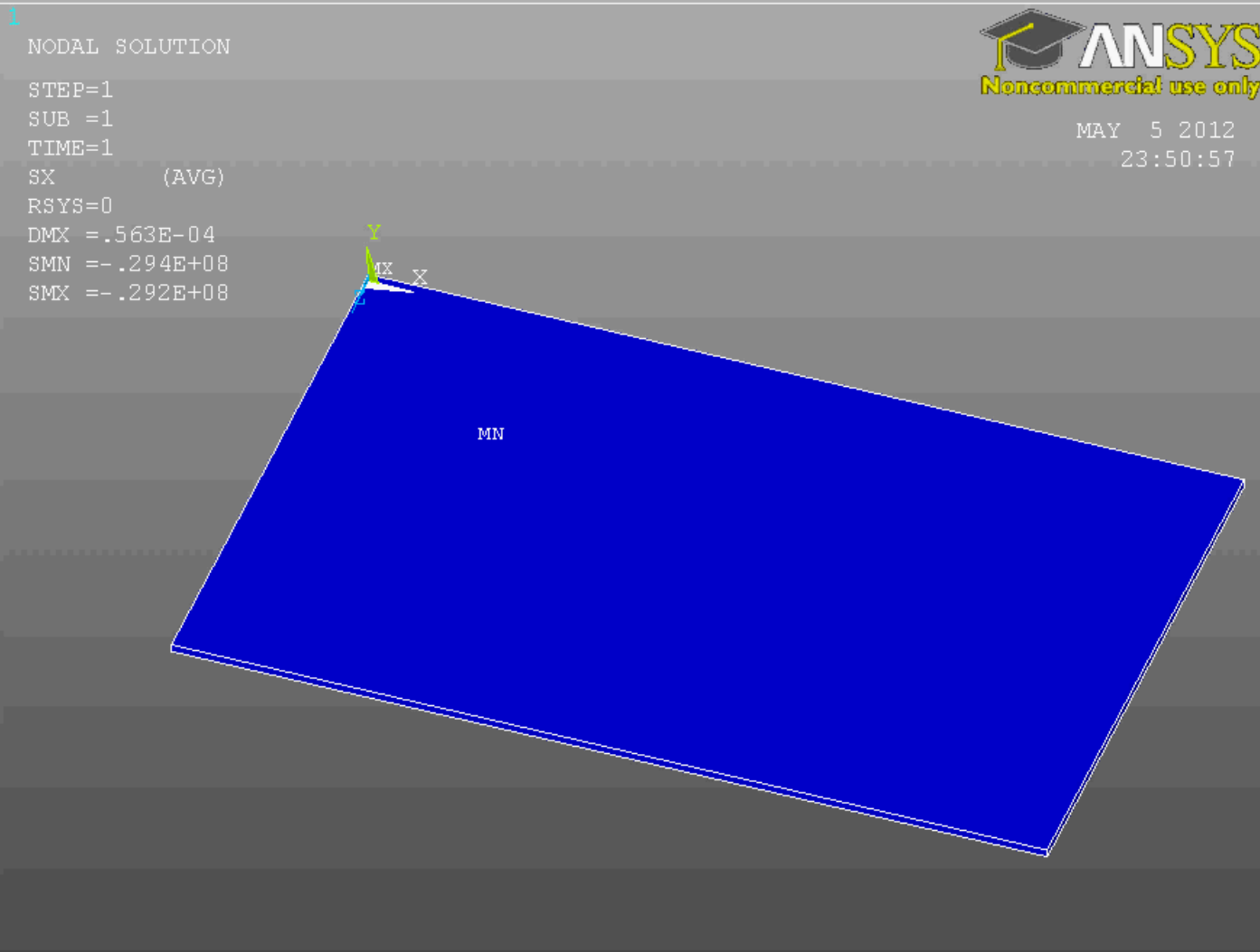
**SOLID 226 - 20 nodes  
Piezoelectric Element**



**SOLID 185 - 8 nodes  
Structural Element**

# Theoretical Modeling

Pi



1 use  
: 20  
:52:

# Theoretical Modeling

M

1

NODAL SOLUTION

STEP=1

SUB =1

TIME=1

SX (AVG)

RSYS=0

DMX =.006325

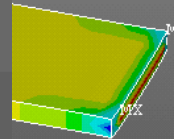
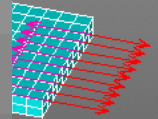
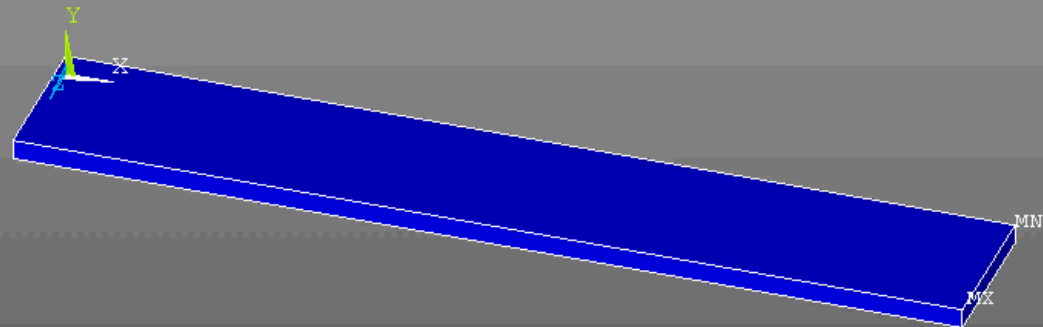
SMN =-.462E+07

SMX =.243E+08



MAY 6 2012

00:16:27



(NOAVG)

18  
E+08  
E+08



Total Displacement U = 0.525 mm

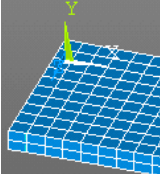
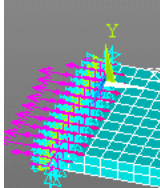
.157E+08

.157E+08



# Theoretical Modeling

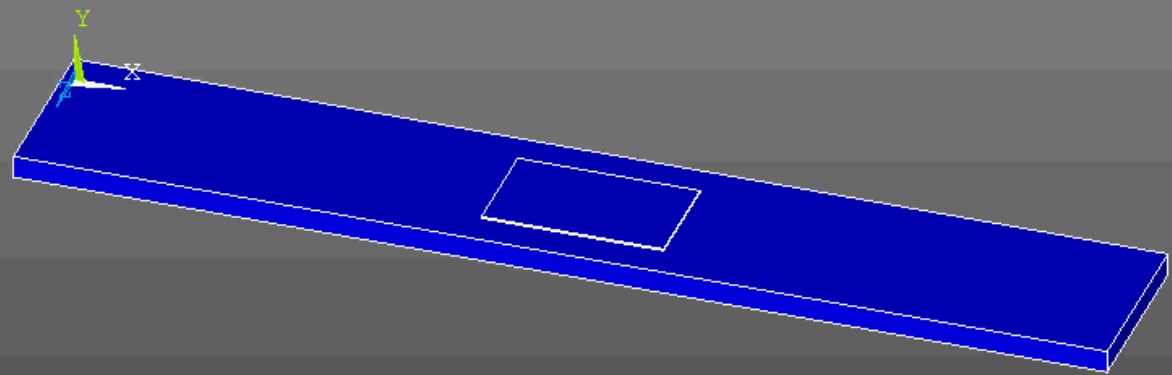
M



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1
NODAL SOLUTION
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SUB =1
TIME=1
EPTOX (AVG)
RSYS=0
DMX =.00569
SMN =-.01054
SMX =.033756
```



MAY 6 2012  
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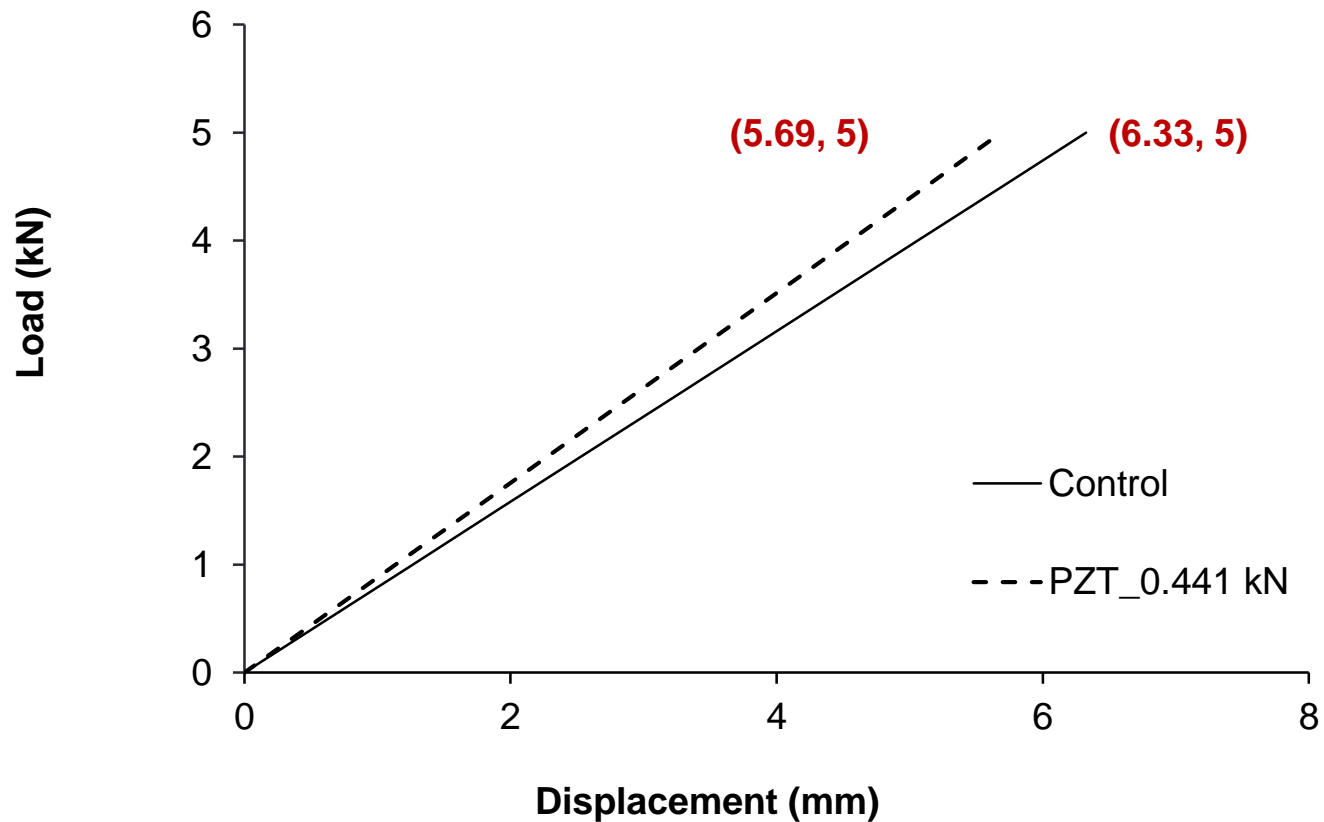


ANSYS  
Noncommercial use only  
MAY 3 2012  
15:05:35

.666E+07 .707E+07

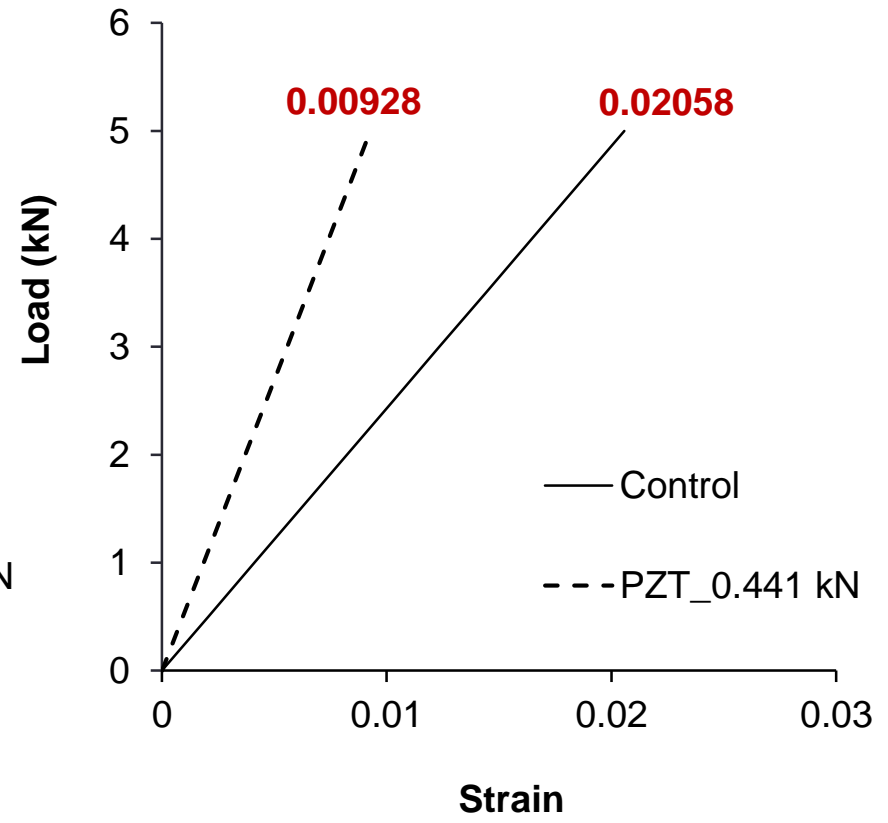
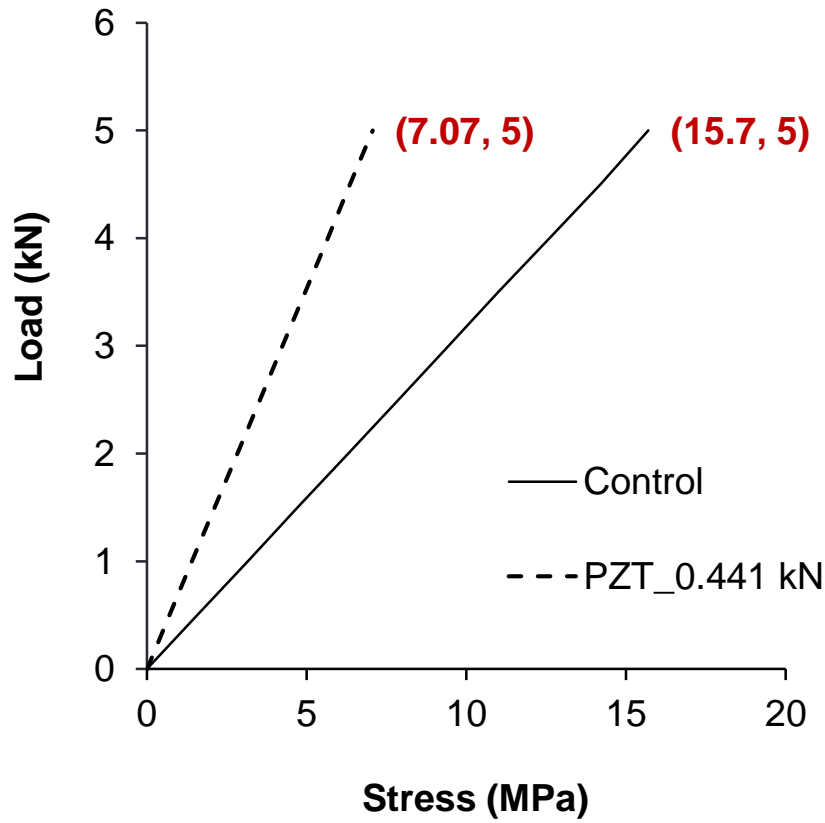
# Results and Discussion

## Actuation Reduces Displacement



# Results and Discussion

## Actuation Reduces Local Stress and Strain



# Preliminary Conclusions and On-Going Work

- **Theoretical modeling was successful in reducing localized stress in the composite strip**
- **These results show that localized stress alleviation of composite materials is a promising concept**
- **Select best material for physical experiment**
  - Possible candidates are piezoelectric actuators (PZT) or shape memory alloy (SMA)
- **Begin phase 2 and 3 of research plan**
  - Create detection and triggering system
  - Design recommendations for practical applications

# SHAPE MEMORY ALLOY ALTERNATIVE

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# Material Properties of SMA

- Made of nickel-titanium
- Contract to typically 2% to 5% of their length
- Density = 0.235 lb/in<sup>3</sup> (6.45 g/cm<sup>3</sup>)
- Melting Point = 2370 °F (1300 °C)
- Thermal Conductivity = 10.4 BTU/hr \* ft \* °F (0.18 W/cm \* °C)
- Anti-Corrosive
- Young's Modulus
  - Low Temp Phase = 28-40 GPa
  - High Temp Phase = 86 GPa

# Testing Size and Electrical Guidelines

- Diameter size = 0.020in (0.51mm)
- Resistance ohms/inch (ohms/meter) = 0.11 (4.3)
- Pull Force - pounds (grams) = 7.85 (3560)
- Approximate Current for 1 Second Contraction = 4000mA

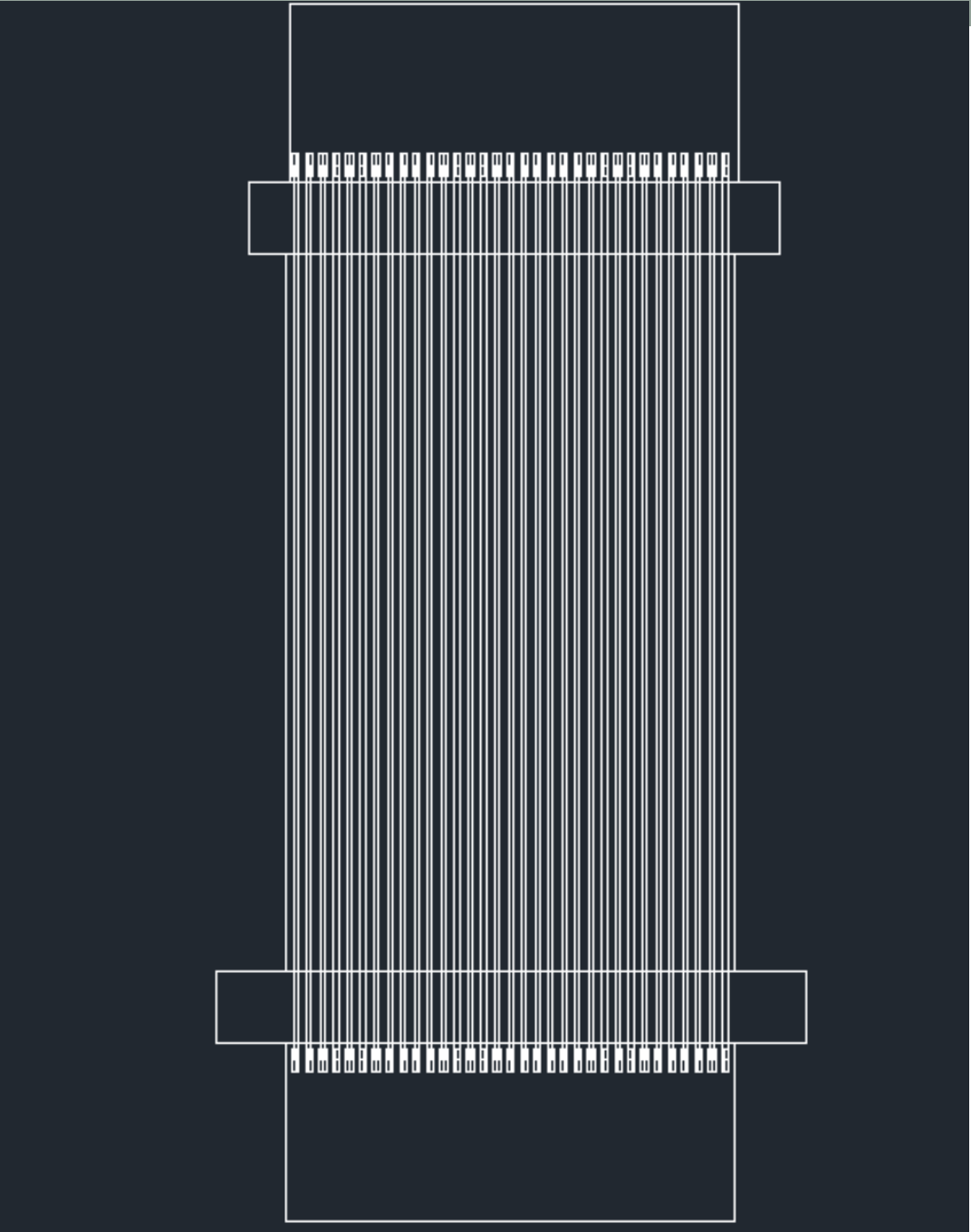
# Cycle Time

- Contraction occurs from the current heating the wire
- Reaction occurs when there is a cooling effect or lack of current
- Current which will heat the wire from room temperature to over 212 °F (100°C) in 1 millisecond
- Any current application will need to be cycled
- Depending on our test results, a cooling method may need to be used



# Options for attaching physically

- Screws
- Wedged into a PC board
- Glued into a channel with conductive epoxies
- Crimping –works the best because the wire expands inside the crimp under loading
- Soldering does not work due to high temps and expansion



# Acknowledgments

**NASA North Dakota Space Grant Consortium**

**North Dakota Experimental Program to Simulate  
Competitive Research (EPSCoR) Grant**

**SpaceAge Synthetics, Inc.**

